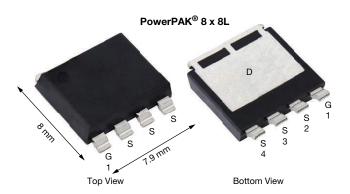
SQJQ184E

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Automotive N-Channel 80 V (D-S) 175 °C MOSFET

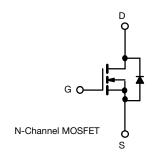


PRODUCT SUMMARY	
V _{DS} (V)	80
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0014
I _D (A)	430
Configuration	Single
Package	PowerPAK 8 x 8L

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Thin 1.6 mm height
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





ABSOLUTE MAXIMUM RATING	iS (T _C = 25 °C, unless	otherwise noted)			
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	80			
Gate-source voltage		V _{GS}	± 20	V		
Continuous drain current T _C = 25 °C		1	430			
Continuous drain current	T _C = 125 °C	I _D	250			
Continuous source current (diode conduction	on)	۱ _S	450	А		
Pulsed drain current ^a		I _{DM}	1200			
Single pulse avalanche current	L = 0.1 mH	I _{AS}	65			
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	211	mJ		
Maximum power dissipation	T _C = 25 °C	Р	600	W		
maximum power dissipation	T _C = 125 °C	P _D	200	vv		
Operating junction and storage temperature	e range	T _J , T _{stg}	-55 to +175	°C		
Soldering recommendations (peak temperat	ture) ^c		260	C		

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^b	R _{thJA}	40	°C/W
Junction-to-case (drain)		R _{thJC}	0.25	C/ W

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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SPECIFICATIONS (T _C = 25 °C, u PARAMETER	SYMBOL		T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	STMBOL	120		141114.	1/F.	MAA.	
Drain-source breakdown voltage	V _{DS}	Vcs	= 0, I _D = 250 μA	80	-	-	
Gate-source threshold voltage	V _{GS(th)}		= V _{GS} , I _D = 250 μA	2	3	3.5	V
Gate-source leakage		-	$= 0 \text{ V}, \text{ V}_{\text{GS}} = \pm 20 \text{ V}$	-	-	± 100	nA
	1922	$V_{GS} = 0 V$	V _{DS} = 80 V	-	-	1	10.0
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$ $V_{GS} = 0 V$	$V_{DS} = 80 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$	-	-	50	μA
	.033	$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 175 °C	-	-	500	μ.,
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	50	-	-	Α
	D(OII)	V _{GS} = 10 V	I _D = 20 A	-	0.0011	0.0014	-
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	-	-	0.0026	Ω
		V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	-	-	0.0033	
Forward transconductance b	g _{fs}	V _{DS}	= 15 V, I _D = 15 A	-	82	-	S
Dynamic ^b							
Input capacitance	C _{iss}			-	11 435	16 010	
Output capacitance	Coss	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	1896	2655	pF
Reverse transfer capacitance	C _{rss}			-	92	130	
Total gate charge ^c	Qg			-	181	272	
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 \text{ V}$	$V_{DS} = 40 \text{ V}, I_D = 50 \text{ A}$	-	51	-	nC
Gate-drain charge ^c	Q _{gd}			-	36	-	
Gate resistance	Rg		f = 1 MHz	0.7	1.3	2	Ω
Turn-on delay time ^c	t _{d(on)}			-	21	28	
Rise time ^c	t _r		= 40 V, R _L = 0.8 Ω,	-	80	105	ns
Turn-off delay time ^c	t _{d(off)}	I _D ≅ 50 A,	V_{GEN} = 10 V, R_g = 1 Ω	-	65	85	115
Fall time ^c	t _f			-	20	28	
Source-Drain Diode Ratings and Charac	teristics ^b						
Pulsed current ^a	I _{SM}			-	-	1100	А
Forward voltage	V _{SD}	I _F =	40 A, V _{GS} = 0 V	-	0.7	1.2	V
Body diode reverse recovery time	t _{rr}			-	72	144	ns
Body diode reverse recovery charge	Q _{rr}	1 40	A di/dt - 100 A /···	-	143	286	nC
Reverse recovery fall time	t _a	I _F = 10	A, di/dt = 100 A/µs	-	41	-	
Reverse recovery rise time	t _b			-	30	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	3.5	-	А

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

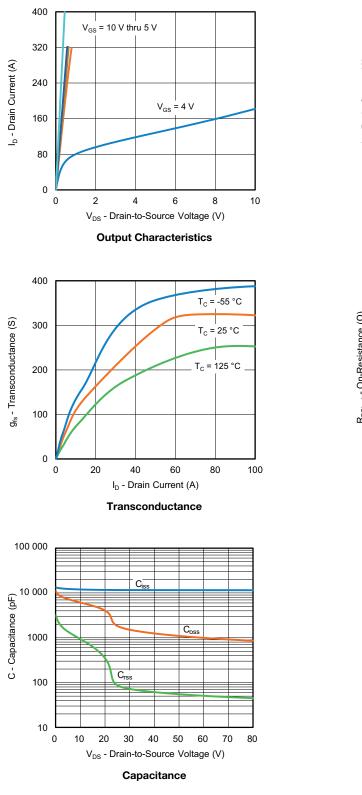
c. Independent of operating temperature

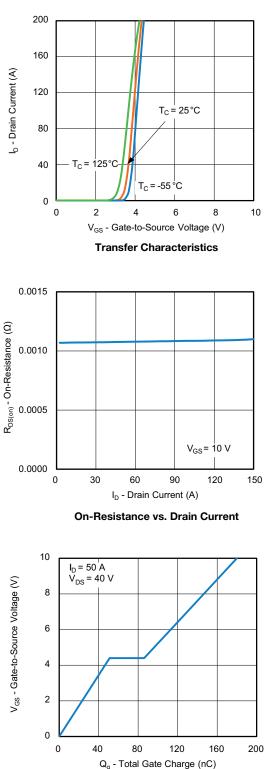
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Gate Charge

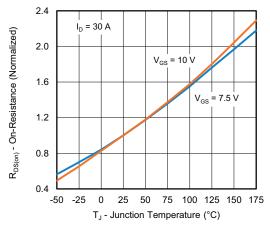
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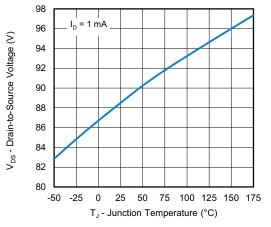
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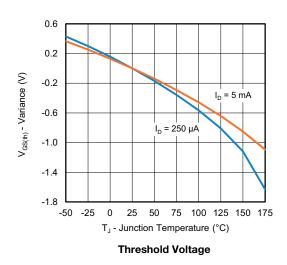
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

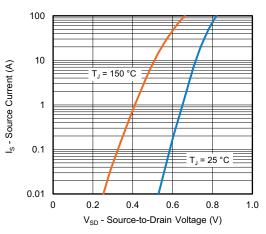


On-Resistance vs. Junction Temperature

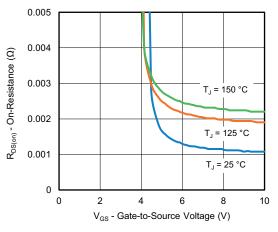


Drain Source Breakdown vs. Junction Temperature

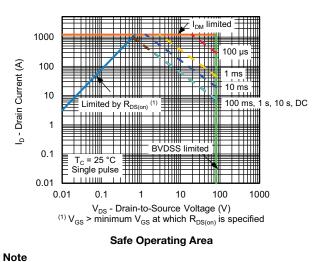




Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

S22-0703-Rev. B, 15-Aug-2022

4 For technical questions, contact: <u>automostechsupport@vishay.com</u> Document Number: 77102

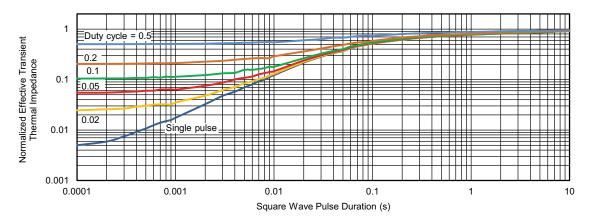
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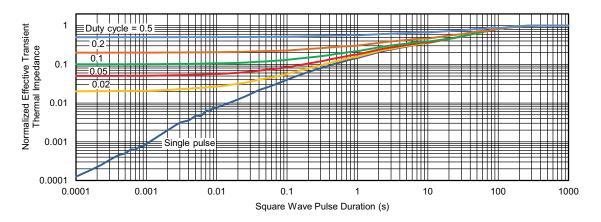
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



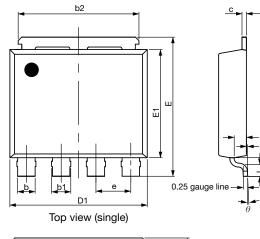
Normalized Thermal Transient Impedance, Junction-to-Ambient

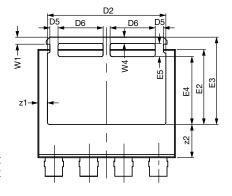
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PowerPAK[®] 8 x 8L BWL Case Outline 2

A1





Bottom view (single)

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F	-		-	-	A.	<
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DIM.		MILLIMETERS			INCHES	
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	1.50	1.60	1.70	0.059	0.063	0.067
A1	0.00	-	0.127	0.000	-	0.005
A2	0.655	0.705	0.755	0.026	0.028	0.030
b	0.92	1.00	1.08	0.036	0.039	0.043
b1	1.02	1.10	1.18	0.040	0.043	0.046
b2	6.84	6.94	7.04	0.269	0.273	0.277
С	0.20	0.25	0.30	0.008	0.010	0.012
D1	7.80	7.90	8.00	0.307	0.311	0.315
D2	6.70	6.80	6.90	0.264	0.268	0.272
D5	0.37	0.47	0.57	0.015	0.019	0.022
D6	2.49	2.59	2.69	0.098	0.102	0.106
е	1.97	2.00	2.03	0.078	0.079	0.080
Е	7.90	8.00	8.10	0.311	0.315	0.319
E1	6.12	6.22	6.32	0.241	0.245	0.249
E2	4.21	4.31	4.41	0.166	0.170	0.174
E3	4.92	5.02	5.12	0.194	0.198	0.202
E4	3.80	3.90	4.00	0.150	0.154	0.157
E5	0.65	0.75	0.85	0.026	0.030	0.033
L	0.61	0.68	0.75	0.024	0.027	0.030
L1	1.00	1.07	1.15	0.039	0.042	0.045
W1	0.30	0.40	0.50	0.012	0.016	0.020
W4	0.32	0.37	0.42	0.013	0.015	0.017
z1	0.45	0.55	0.65	0.018	0.022	0.026
z2	1.81	1.91	2.01	0.071	0.075	0.079
θ	0°	-	5°	0°	-	5°
N: S19-0643-F G: 6073	lev. B, 05-Aug-2019					

Note

• Millimeter will govern

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Revison: 05-Aug-2019



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